Features





Low-Noise Step-Up DC-DC Converter

General Description

The MAX17067 boost converter incorporates highperformance (at 1.2MHz), current-mode, fixed-frequency, pulse-width modulation (PWM) circuitry with a built-in 0.15Ω n-channel MOSFET to provide a highly efficient regulator with fast response.

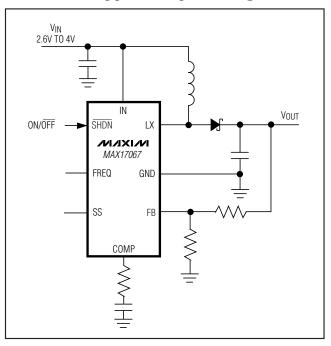
High switching frequency (640kHz or 1.2MHz selectable) allows for easy filtering and faster loop performance. An external compensation pin provides the user flexibility in determining loop dynamics, allowing the use of small, low equivalent-series-resistance (ESR) ceramic output capacitors. The device can produce an output voltage as high as 18V.

Soft-start is programmed with an external capacitor, which sets the input-current ramp rate. The MAX17067 is available in a space-saving 8-pin µMAX® package. The ultrasmall package and high switching frequency allow the total solution to be less than 1.1mm high.

Application

LCD Displays

Typical Operating Circuit



♦ 90% Efficiency

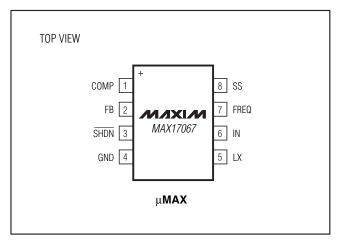
- ♦ Adjustable Output from V_{IN} to 18V
- ♦ 2.4A, 0.15Ω, 22V Power MOSFET
- ♦ +2.6V to +4.0V Input Range
- ♦ Pin-Selectable 640kHz or 1.2MHz Switching Frequency
- ♦ Programmable Soft-Start
- ♦ Small 8-Pin µMAX Package
- ◆ Integrated Input Voltage Clamp Circuit

Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	PKG CODE
MAX17067EUA+	-40°C to +85°C	8 µMAX	U8+1

+ Denotes a lead-free package.

Pin Configuration



μΜΑΧ is a registered trademark of Maxim Integrated Products, Inc.

ABSOLUTE MAXIMUM RATINGS

LX to GND0.3V to +22V	Continuous Power Dissipation ($T_A = +70^{\circ}C$)
SHDN, FREQ to GND0.3V to +7.5V	8-Pin µMAX (derate 4.1mW/°C above +70°C)330mW
IN to GND (Note 1)0.3V to +6V	Operating Temperature Range40°C to +85°C
SS, COMP, FB to GND0.3V to (V _{IN} + 0.3V)	Junction Temperature+150°C
RMS LX Pin Current1.2A	Storage Temperature Range65°C to +150°C
	Lead Temperature (soldering, 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = \overline{SHDN} = 3V, FREQ = 3V, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ Typical values are at $T_A = +25^{\circ}C.$) (Note 2)

PARAMETER	PARAMETER SYMBOL CONDITIONS		MIN	TYP	MAX	UNITS
Input Supply Range	VIN	V _{OUT} < 18V	2.6		4.0	V
Output Voltage					18	V
Input Supply Clamp Voltage		Use external limiting resistor; $R_{IN} = 100\Omega$, $V_{IN} = 10V$ (Note 3)	6.05	6.40	6.60	V
V _{IN} Undervoltage Lockout	UVLO	V _{IN} rising, typical hysteresis is 50mV, LX remains off below this level	2.30	2.45	2.57	V
Quiescent Current	Local	V _{FB} = 1.3V, not switching		0.3	0.6	m A
Quiescent Current	IIN	V _{FB} = 1.0V, switching		1.5	2.5	mA
Chutdown Cunnly Current	Luc	SHDN = GND, T _A = +25°C		30	60	
Shutdown Supply Current	IIN	SHDN = GND, T _A = +85°C		30		μΑ
ERROR AMPLIFIER						
Feedback Voltage	V _{FB}	Level to produce V _{COMP} = 1.24V	1.23	1.24	1.25	V
FB Input Bias Current	I _{FB}	V _{FB} = 1.24V	50	125	200	nA
Feedback-Voltage Line Regulation		Level to produce V _{COMP} = 1.24V, 2.6V < V _{IN} < 5.5V		0.05	0.15	%/V
Transconductance	Яm	$\Delta I = 5\mu A$	100	240	440	μS
Voltage Gain	Ay			3800		V/V
OSCILLATOR	'		•			
Fraguesay	6	FREQ = GND	500	640	780	kHz
Frequency	fosc	FREQ = IN	1000	1200	1400	KHZ
Maximum Duty Cycle	DC	FREQ = GND, FREQ = IN	89	92	95	%
n-CHANNEL SWITCH			•			
Current Limit	ILIM	V _{FB} = 1V, duty cycle = 68% (Note 4)	1.8	2.4	3.4	А
On-Resistance	Ron			150	275	mΩ
Leakage Current	ILXOFF	V _L X = 20V		10	20	μΑ
Current-Sense Transresistance	Rcs		0.2	0.3	0.4	V/A
SOFT-START	1	'	1			
Reset Switch Resistance					100	Ω
Charge Current		V _{SS} = 1.2V	2.5	4.5	6.5	μΑ

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = \overline{SHDN} = 3V, FREQ = 3V, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ Typical values are at $T_A = +25^{\circ}C.$) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		TYP	MAX	UNITS
CONTROL INPUTS						
Input Low Voltage	VIL	$\overline{\text{SHDN}}$, FREQ, $V_{\text{IN}} = 2.6V$ to 4.0V			0.3 x V _{IN}	V
Input High Voltage	V _{IH}	$\overline{\text{SHDN}}$, FREQ, $V_{\text{IN}} = 2.6V$ to $4.0V$	0.7 x V _{IN}			V
Hysteresis		SHDN, FREQ		0.1 x V _{IN}		V
FREQ Pulldown Current	IFREQ		3	6	9	μΑ
SHDN Input Current	launu	SHDN = GND, TA = +25°C	-1		+1	
3HDN Input Current	ISHDN	SHDN = GND, TA = +85°C		0		μΑ
Thermal Shutdown		Temperature rising		160	•	°C
THEITIAI SHULUOWII		Hysteresis		20		

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = \overline{SHDN} = 3V, FREQ = 3V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.})$ (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Supply Range	VIN	V _{OUT} < 18V	2.6		4.0	V
Output Voltage Range					18	V
Input Supply Clamp Voltage		Use external limiting resistor; $R_{IN} = 100\Omega$, $V_{IN} = 10V$ (Note 3)	6.03		6.60	V
VIN Undervoltage Lockout	VIN Undervoltage Lockout UVLO VIN rising, typical hysteresis is 80mV, LX remains off below this level		2.30		2.57	V
Quiescent Current	Live	V _{FB} = 1.3V, not switching			0.6	mA
Quiescent Current	I _{IN}	V _{FB} = 1.0V, switching			2.5	1 IIIA
ERROR AMPLIFIER						
Feedback Voltage	V _{FB}	Level to produce V _{COMP} = 1.24V	1.227		1.253	V
FB Input Bias Current	I _{FB}	V _{FB} = 1.24V			200	nA
Feedback-Voltage Line Regulation		Level to produce V _{COMP} = 1.24V, 2.6V < V _{IN} < 4.0V			0.15	%/V
Transconductance	9m	$\Delta I = 5\mu A$	100		440	μS
OSCILLATOR	-					
Fraguenay	f	FREQ = GND	450		830	I/LI=
Frequency	fosc	FREQ = IN	950		1500	kHz
Maximum Duty Cycle	DC	FREQ = GND, FREQ = V _{IN}	89		95	%

ELECTRICAL CHARACTERISTICS (continued)

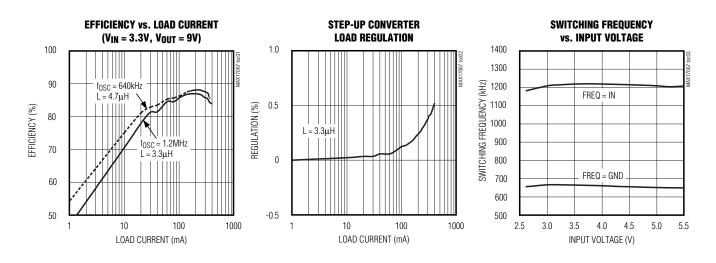
 $(V_{IN} = \overline{SHDN} = 3V, FREQ = 3V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}) \text{ (Note 1)}$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
n-CHANNEL SWITCH						
Current Limit	I _{LIM}	V _{FB} = 1V, duty cycle = 68% (Note 4)	1.8		3.4	А
On-Resistance	Ron	V _{IN} = 3V			275	Ω
Current-Sense Transresistance	Rcs		0.19		0.40	V/A
SOFT-START						
Reset Switch Resistance					100	Ω
Charge Current		V _{SS} = 1.2V	2.5		6.5	μΑ
CONTROL INPUTS						
Input Low Voltage	V _{IL}	$\overline{\text{SHDN}}$, FREQ, $V_{\text{IN}} = 2.6V$ to 4.0V			0.3 x V _{IN}	V
Input High Voltage	VIH	SHDN, FREQ, V _{IN} = 2.6V to 4.0V	0.7 x V _{IN}			V

- **Note 1:** Limit on IN absolute maximum ratings is for operation without the use of an external resistor for the internal clamp circuit. See the *IN Supply Clamp Circuit* section for IN voltage limits during clamping circuit operation.
- Note 2: Limits are 100% production tested at T_A = +25°C. Maximum and minimum limits over temperature are guaranteed by design and characterization.
- **Note 3:** See the *IN Supply Clamp Circuit* section to properly size the external resistor.
- Note 4: Current limit varies with duty-cycle slope compensation. See the Output-Current Capability section.

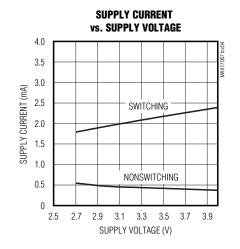
Typical Operating Characteristics

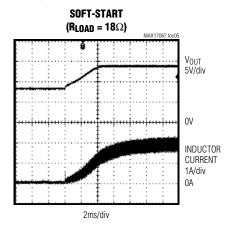
(Circuit of Figure 1, V_{IN} = 3.3V, f_{OSC} = 640kHz, T_A = +25°C, unless otherwise noted.)



Typical Operating Characteristics (continued)

(Circuit of Figure 1, V_{IN} = 3.3V, f_{OSC} = 640kHz, T_A = +25°C, unless otherwise noted.)





PULSED LOAD-TRANSIENT RESPONSE

(I_{LOAD} = 40mA TO 1.1A)

10µs/div

I_{OUT} 1A/div

0.1A

Vout 200mV/div

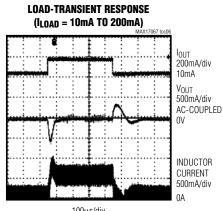
AC-COUPLED 0V

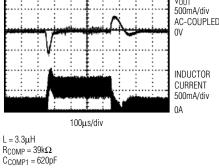
INDUCTOR

CURRENT

1A/div

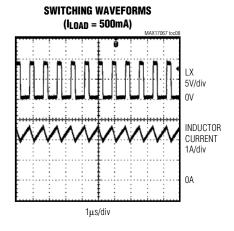
9V





 $L=3.3\mu H$ $R_{COMP} = 39k\Omega$





Pin Description

PIN	NAME	FUNCTION
1	COMP	Compensation Pin for Error Amplifier. Connect a series RC from COMP to ground. See the <i>Loop Compensation</i> section for component selection guidelines.
2	FB	Feedback Pin. Reference voltage is 1.24V nominal. Connect an external resistor-divider tap to FB and minimize the trace area. Set V _{OUT} according to: V _{OUT} = 1.24V (1 + R1 / R2). See Figure 1.
3	SHDN	Active-Low Shutdown Control Input. Drive SHDN low to turn off the MAX17067.
4	GND	Ground
5	LX	Switch Pin. Connect the inductor/catch diode to LX and minimize the trace area for lowest EMI.
6	IN	Supply Pin. Bypass IN with at least a 1µF ceramic capacitor directly to GND.
7	FREQ	Frequency Select Input. When FREQ is low, the oscillator frequency is set to 640kHz. When FREQ is high, the frequency is 1.2MHz. This input has a 5µA pulldown current.
8	SS	Soft-Start Control Pin. Connect a soft-start capacitor (C_{SS}) to this pin. Leave open for no soft-start. The soft-start capacitor is charged with a constant current of 4 μ A. Full current limit is reached after t = 2.5 x 10 ⁵ Css. The soft-start capacitor is discharged to ground when \overline{SHDN} is low. When \overline{SHDN} goes high, the soft-start capacitor is charged to 0.5V, after which soft-start begins.

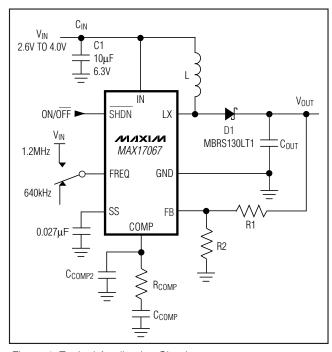


Figure 1. Typical Application Circuit

_Detailed Description

The MAX17067 is a highly efficient power supply that employs a current-mode, fixed-frequency PWM architecture for fast-transient response and low-noise operation. The device regulates the output voltage through a combination of an error amplifier, two comparators, and several signal generators (Figure 2). The error amplifier compares the signal at FB to 1.24V and varies the COMP output. The voltage at COMP determines the current trip point each time the internal MOSFET turns on. As the load varies, the error amplifier sources or sinks current to the COMP output accordingly to produce the inductor peak current necessary to service the load. To maintain stability at high duty cycle, a slope-compensation signal is summed with the current-sense signal.

At light loads, this architecture allows the ICs to "skip" cycles to prevent overcharging the output voltage. In this region of operation, the inductor ramps up to a fixed peak value, discharges to the output, and waits until another pulse is needed again.

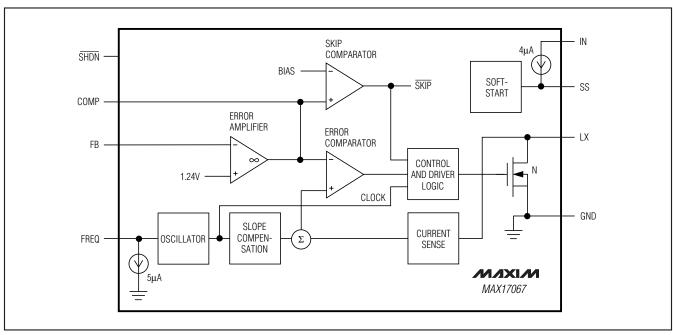


Figure 2. Functional Diagram

IN Supply Clamp Circuit

The MAX17067 features an internal clamp to allow applications where there is overvoltage stress on the supply line. In many cases, high-voltage spikes happen on production lines and are difficult to protect against. The MAX17067's internal clamp circuit can solve this problem. The internal clamp circuit limits the voltage at the IN pin to 6.4V (typ) to protect the IN pin from a continuous or transient overvoltage stress condition on the supply line. To use the clamp circuit, put a series resistor (RIN) between supply and IN, and a decoupling capacitor (1µF typical) from IN to GND. To properly size the external resistor, several factors should be considered:

 The maximum current for the clamp is 40mA, and the clamp voltage at the IN pin is 6.05V (min). Therefore, the external resistor is:

$$R_{IN} \ge [(V_{IN} - 6.05)/0.04]\Omega$$

 Power dissipation in the clamp is in addition to the total power loss. The external resistor causes a DC voltage drop in the IN supply line. The voltage at the IN pin has to be properly maintained when clamping is used. The worst-case quiescent current of the IN pin is 2.5mA; therefore, the worst-case voltage drop is 2.5mA multiplied by R_{IN}.

Output-Current Capability

The output-current capability of the MAX17067 is a function of current limit, input voltage, operating frequency, and inductor value. Because of the slope compensation used to stabilize the feedback loop, the duty cycle affects the current limit. The output-current capability is governed by the following equation:

$$I_{OUT(MAX)} = [I_{LIM} \times (1.26 - 0.4 \times Duty) - 0.5 \times Duty \times V_{IN}/(f_{OSC} \times L)] \times \eta \times V_{IN}/V_{OUT}$$

where:

I_{LIM} = current limit specified at 68% (see the *Electrical Characteristics*):

$$\begin{aligned} \text{Duty} &= \text{duty cycle} = (\text{Vout} - \text{Vin} + \text{VDIODE}) \\ & (\text{Vout} - \text{I}_{\text{LIM}} \times \text{Ron} + \text{VDIODE}) \end{aligned}$$

 V_{DIODE} = catch diode forward voltage at I_{LIM} η = conversion efficiency, 85% nominal

Soft-Start

The MAX17067 can be programmed for soft-start upon power-up with an external capacitor. When the shutdown pin is taken high, the soft-start capacitor (Css) is immediately charged to 0.5V. Then the capacitor is charged at a constant current of 4.5µA (typ). During this time, the SS voltage directly controls the peak inductor current, allowing 0A at Vss = 0.5V to the full current limit at Vss = 1.5V. The maximum load current is available after the soft-start cycle is completed. When the shutdown pin is taken low, the soft-start capacitor is discharged to ground.

Frequency Selection

The MAX17067's frequency can be user selected to operate at either 640kHz or 1.2MHz. Connect FREQ to GND for 640kHz operation. For a 1.2MHz switching frequency, connect FREQ to IN. This allows the use of small, minimum-height external components while maintaining low output noise. FREQ has an internal pulldown, allowing the user the option of leaving FREQ unconnected for 640kHz operation.

Shutdown

The MAX17067 is shut down to reduce the supply current to $30\mu\text{A}$ when $\overline{\text{SHDN}}$ is low. In this mode, the internal reference, error amplifier, comparators, and biasing circuitry turn off while the n-channel MOSFET is turned off. The boost converter's output is connected to IN by the external inductor and catch diode.

Thermal-Overload Protection

Thermal-overload protection prevents excessive power dissipation from overheating the MAX17067. When the junction temperature exceeds $T_J = +160^{\circ}\text{C}$, a thermal sensor immediately activates the fault protection, which shuts down the MAX17067, allowing the device to cool down. Once the device cools down by approximately 20°C , it returns to normal operation.

Applications Information

Boost DC-DC converters using the MAX17067 can be designed by performing simple calculations for a first iteration. All designs should be prototyped and tested prior to production. Table 1 provides a list of components for a range of standard applications. Table 2 lists component suppliers.

External component value choice is primarily dictated by the output voltage and the maximum load current, as well as maximum and minimum input voltages. Begin by selecting an inductor value. Once L is known, choose the diode and capacitors.

Inductor Selection

The minimum inductance value, peak current rating, and series resistance are factors to consider when selecting the inductor. These factors influence the converter's efficiency, maximum output load capability, transient-response time, and output voltage ripple. Physical size and cost are also important factors to be considered.

Table 1. Component Selection

	-							
V _{IN} (V)	VOUT (V)	fosc (Hz)	L (µH)	C _{OUT} (µF)	RCOMP (k)	CCOMP (pF)	CCOMP2 (pF)	IOUT(MAX) (mA)
3.3	9	1.2M	3.3	10	121	620	10	250
3.3	9	640k	4.7	10	82	1000	10	250

Table 2. Component Suppliers

CUIDDUIED	SUPPLIER PHONE FAX							
	PHONE	FAA						
Inductors								
Coilcraft	847-639-6400	847-639-1469						
Coiltronics	561-241-7876	561-241-9339						
Sumida USA	847-956-0666	847-956-0702						
TOKO	847-297-0070	847-699-1194						
Capacitors		•						
AVX	803-946-0690	803-626-3123						
KEMET	408-986-0424	408-986-1442						
SANYO	619-661-6835	619-661-1055						
Taiyo Yuden	408-573-4150	408-573-4159						

SUPPLIER	PHONE	FAX				
Diodes						
Central Semiconductor	516-435-1110	516-435-1824				
International Rectifier	310-322-3331	310-322-3332				
Motorola	602-303-5454	602-994-6430				
Nihon	847-843-7500	847-843-2798				
Zetex	516-543-7100	516-864-7630				

The maximum output current, input voltage, output voltage, and switching frequency determine the inductor value. Very high inductance values minimize the current ripple and therefore reduce the peak current, which decreases core losses in the inductor and I²R losses in the entire power path. However, large inductor values also require more energy storage and more turns of wire, which increase physical size and can increase I²R losses in the inductor. Low inductance values decrease the physical size but increase the current ripple and peak current. Finding the best inductor involves choosing the best compromise between circuit efficiency, inductor size, and cost.

The equations used here include a constant LIR, which is the ratio of the inductor peak-to-peak ripple current to the average DC inductor current at the full load current. The best trade-off between inductor size and circuit efficiency for step-up regulators generally has an LIR between 0.3 and 0.5. However, depending on the AC characteristics of the inductor core material and the ratio of inductor resistance to other power path resistances, the best LIR can shift up or down. If the inductor resistance is relatively high, more ripple can be accepted to reduce the number of turns required and increase the wire diameter. If the inductor resistance is relatively low, increasing inductance to lower the peak current can decrease losses throughout the power path. If extremely thin high-resistance inductors are used, as is common for LCD-panel applications, the best LIR can increase to between 0.5 and 1.0.

Once a physical inductor is chosen, higher and lower values of the inductor should be evaluated for efficiency improvements in typical operating regions.

Calculate the approximate inductor value using the typical input voltage (VIN), the maximum output current (IMAIN(MAX)), the expected efficiency (η_{TYP}) taken from an appropriate curve in the *Typical Operating Characteristics*, and an estimate of LIR based on the above discussion:

$$L = \left(\frac{V_{IN}}{V_{MAIN}}\right)^{2} \left(\frac{V_{MAIN} - V_{IN}}{I_{MAIN(MAX)} \times f_{OSC}}\right) \left(\frac{\eta_{TYP}}{LIR}\right)$$

Choose an available inductor value from an appropriate inductor family. Calculate the maximum DC input current at the minimum input voltage $V_{IN(MIN)}$ using conservation of energy and the expected efficiency at that operating point (η_{MIN}) taken from an appropriate curve in the *Typical Operating Characteristics*:

$$I_{IN(DC,MAX)} = \frac{I_{MAIN(MAX)} \times V_{MAIN}}{V_{IN(MIN)} \times \eta_{MIN}}$$

Calculate the ripple current at that operating point and the peak current required for the inductor:

$$I_{RIPPLE} = \frac{V_{IN(MIN)} \times (V_{MAIN} - V_{IN(MIN)})}{L \times V_{MAIN} \times f_{OSC}}$$

$$I_{PEAK} = I_{IN(DC,MAX)} + \frac{I_{RIPPLE}}{2}$$

The inductor's saturation current rating and the MAX17067s' LX current limit (I_{LIM}) should exceed IPEAK and the inductor's DC current rating should exceed IIN(DC,MAX). For good efficiency, choose an inductor with less than 0.1Ω series resistance.

Considering the application circuit in Figure 4, the maximum load current (I_{MAIN(MAX)}) is 250mA with a 9V output and a typical input voltage of 3.3V. Choosing an LIR of 0.7 and estimating efficiency of 85% at this operating point:

$$L = \left(\frac{3.3V}{9V}\right)^{2} \left(\frac{9V - 3.3V}{0.25A \times 1.2MHz}\right) \left(\frac{0.85}{0.7}\right) \approx 3.3\mu H$$

Using the application's minimum input voltage (3V) and estimating efficiency of 80% at that operating point:

$$I_{IN(DC,MAX)} = \frac{0.25A \times 9V}{3V \times 0.8} \approx 0.94A$$

The ripple current and the peak current are:

$$I_{RIPPLE} = \frac{3V \times (9V - 3V)}{3.3\mu H \times 9V \times 1.2MHz} \approx 0.51A$$

$$I_{PEAK} = 0.94A + \frac{0.51A}{2} \approx 1.19A$$

Diode Selection

The output diode should be rated to handle the output voltage and the peak switch current. Make sure that the diode's peak current rating is at least IpK and that its breakdown voltage exceeds V_{OUT} . Schottky diodes are recommended.

Input and Output Capacitor Selection

Low-ESR capacitors are recommended for input bypassing and output filtering. Low-ESR tantalum capacitors are a good compromise between cost and performance. Ceramic capacitors are also a good choice. Avoid standard aluminum electrolytic capacitors. A simple equation to estimate input and output-capacitor values for a given voltage ripple is as follows:

$$C \ge \frac{0.5 \times L \times (IPK^2)}{V_{RIPPLE} \times V_{OUT}}$$

where $V_{\mbox{\scriptsize RIPPLE}}$ is the peak-to-peak ripple voltage on the capacitor.

Output Voltage

The MAX17067 operates with an adjustable output from V_{IN} to 20V. Connect a resistor voltage-divider to FB (see the *Typical Operating Circuit*) from the output to GND. Select the resistor values as follows:

$$R1 = R2 \left(\frac{V_{OUT}}{V_{FB}} - 1 \right)$$

where V_{FB}, the boost-regulator feedback set point, is 1.24V. Since the input bias current into FB is typically zero, R2 can have a value up to $100 k\Omega$ without sacrificing accuracy. Connect the resistor-divider as close to the IC as possible.

Loop Compensation

The voltage feedback loop needs proper compensation to prevent excessive output ripple and poor efficiency caused by instability. This is done by connecting a resistor (RCOMP) and capacitor (CCOMP) in series from COMP to GND, and another capacitor (CCOMP2) from

COMP to GND. RCOMP is chosen to set the high-frequency integrator gain for fast-transient response, while CCOMP is chosen to set the integrator zero to maintain loop stability. The second capacitor, CCOMP2, is chosen to cancel the zero introduced by output-capacitance ESR. For optimal performance, choose the components using the following equations:

$$\begin{aligned} \text{R}_{\text{COMP}} &= (274 \Omega / \text{A}^2 \times \text{V}_{\text{IN}} \times \text{V}_{\text{OUT}} \times \text{C}_{\text{OUT}} / (\text{L} \times \text{I}_{\text{OUT}}) \\ & \text{C}_{\text{COMP}} \cong (0.36 \times 10^{-3} \text{ A} / \Omega) \times \text{L/V}_{\text{IN}} \end{aligned}$$

 $C_{COMP2} \cong (0.0036 \text{ A/}\Omega) \times Resr \times L \times I_{OUT}/(V_{IN} \times V_{OUT})$

For the ceramic output capacitor, where ESR is small, C_{COMP2} is optional. Table 1 shows experimentally verified external component values for several applications. The best gauge of correct loop compensation is by inspecting the transient response of the MAX17067. Adjust R_{COMP} and C_{COMP} as necessary to obtain optimal transient performance.

Soft-Start Capacitor

The soft-start capacitor should be large enough that it does not reach final value before the output has reached regulation. Calculate Css to be:

$$C_{SS} \ > \ 21 \ \times \ 10^{-6} \ \times \ C_{OUT} \ \left(\frac{{V_{OUT}}^2 \ - \ V_{IN} \ \times \ V_{OUT}}{V_{IN} \ \times \ I_{INRUSH} \ - \ I_{OUT} \ \times \ V_{OUT}} \right)$$

where:

Cout = total output capacitance including any bypass capacitor on the output bus

VOUT = maximum output voltage

INRUSH = peak inrush current allowed

IOUT = maximum output current during power-up stage

V_{IN} = minimum input voltage

The load must wait for the soft-start cycle to finish before drawing a significant amount of load current. The duration after which the load can begin to draw maximum load current is:

$$t_{MAX} = 2.5 \times 10^5 C_{SS}$$

Application Circuits 1-Cell to 3.3V SEPIC Power Supply

Figure 3 shows the MAX17067 in a single-ended primary inductance converter (SEPIC) topology. This topology is useful when the input voltage can be either higher or lower than the output voltage, such as when converting a single lithium-ion (Li+) cell to a 3.3V output. L1A and L1B are two windings on a single inductor. The coupling capacitor between these two windings must be a low-ESR type to achieve maximum efficiency, and must also be able to handle high ripple currents. Ceramic capacitors are best for this application. The circuit in Figure 3 provides 400mA output current at 3.3V output when operating with an input voltage from +2.6V to +4.0V.

AMLCD Application

Figure 4 shows a power supply for active matrix (TFT-LCD) flat-panel displays. Output-voltage transient performance is a function of the load characteristic. Add or remove output capacitance (and recalculate compensation-network component values) as necessary to meet transient performance. Regulation performance for secondary outputs (VGOFF and VGON) depends on the load characteristics of all three outputs.

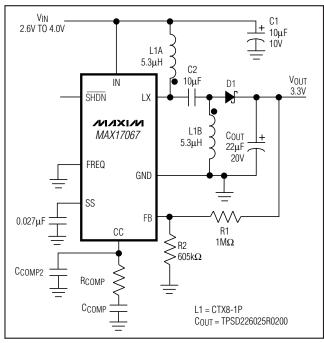


Figure 3. MAX17067 in a SEPIC Configuration

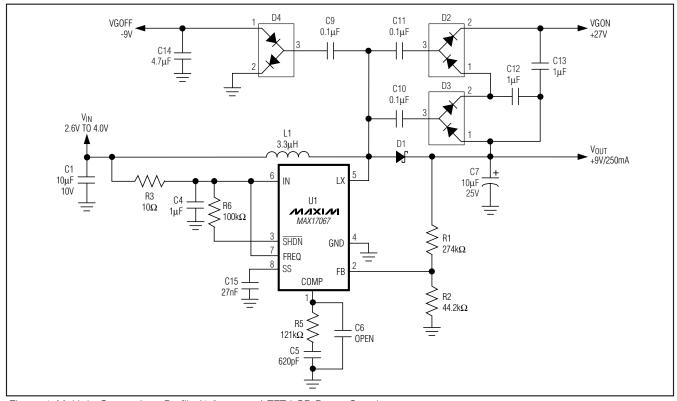


Figure 4. Multiple-Output, Low-Profile (1.2mm max) TFT-LCD Power Supply

Layout Procedure

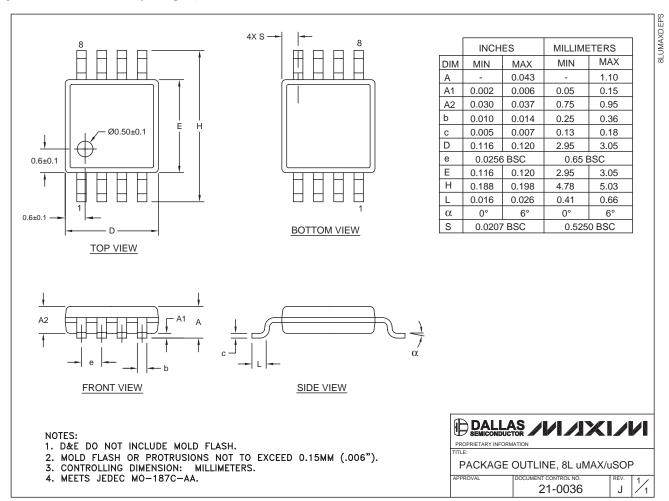
Good PCB layout and routing are required in high-frequency switching power supplies to achieve good regulation, high efficiency, and stability. It is strongly recommended that the evaluation kit PCB layouts be followed as closely as possible. Place power components as close together as possible, keeping their traces short, direct, and wide. Avoid interconnecting the ground pins of the power components using vias through an internal ground plane. Instead, keep the power components close together and route them in a star ground configuration using component-side copper, then connect the star ground to internal ground using multiple vias.

_Chip Information

TRANSISTOR COUNT: 3657

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



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